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Sourcing Simplified

Winstar Display Co., LTD
? ? ? ? ? ? ? ? ? ? ?

SPECIFICATION

CUSTOMER   :

MODULE NO.:   WG24064A-TFH-VZ#

APPROVED BY:

(FOR CUSTOMER USE ONLY)

PCB VERSION: DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

ISSUED DATE:

Winstar Display Co., LTD

? ? ? ? ? ? ? ? ? ?

MODLE NO:

RECORDS OF REVISION			DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2006-3-16		First issue

WS-EP-008 10(A)
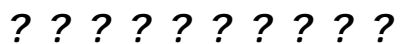
Contents

1.Module Classification Information

W G   2 4 0 6 4   A-   T F H-   VZ#
① ②   ③   ④   ⑤ ⑥ ⑦   ⑧

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H？Character Type, G？Graphic Type

③ Display Font: 240 x 64 dots

④ Model serials no.

⑤ Backlight Type:

N？Without backlight	T？LED, White
B？EL, Blue green	A？LED, Amber
D？EL, Green	R？LED, Red
W？EL, White	O？LED, Orange
F？CCFL, White	G？LED, Green
Y？LED, Yellow Green	

⑥ LCD Mode：

B？TN Positive, Gray	T？FSTN Negative
N？TN Negative,	
G？STN Positive, Gray	
Y？STN Positive, Yellow Green	
M？STN Negative, Blue	
F？FSTN Positive	

⑦ LCD Polarizer Type/ Temperature range/ View direction

A？Reflective, N.T, 6:00	H？Transflective, W.T,6:00
D？Reflective, N.T, 12:00	K？Transflective, W.T,12:00
G？Reflective, W. T, 6:00	C？Transmissive, N.T,6:00
J？Reflective, W. T, 12:00	F？Transmissive, N.T,12:00
B？Transflective, N.T,6:00	I？Transmissive, W. T, 6:00
E？Transflective, N.T.12:00	L？Transmissive, W.T,12:00

⑧ Special Code   T : Built in Negative Voltage ;
                  # : LEAD-FREE;

2.Precautions in use of LCD Modules

(1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
(2)Don't make extra holes on the printed circuit board, modify its shape or change the components of
    LCD module.
(3)Don't disassemble the LCM.
(4)Don't operate it above the absolute maximum rating.
(5)Don't drop, bend or twist LCM.
(6)Soldering: only to the I/O terminals.
(7)Storage: please storage in anti-static electricity container and clean environment.

3.General Specification

Item	Dimension	Unit
Number of Characters	240 x 64 dots	-
Module dimension	188.5 x 65.0 x 14.3(MAX)	mm
View area	133.0 x 39.0	mm
Active area	127.16 x 33.88	mm
Dot size	0.48 x 0.48	mm
Dot pitch	0.53 x 0.53	mm
LCD type	FSTN Positive, Transflective,	
Duty	1/64	
View direction	6 o'clock	
Backlight Type	LED, White	

4.Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	T_{OP}	-20	-	70	?
Storage Temperature	T_{ST}	-30	-	+80	?
Input Voltage	V_I	Vss	-	V_{DD}	V
Supply Voltage For Logic	V_{DD}-V_{SS}	-0.3	-	+7	V
Supply Voltage For LCD	V_{DD}-V_0	0	-	15	V
Negative Voltage Output	V_{EE}	-	10	-	V

5.Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	V_{DD}-V_{SS}	-	4.75	5.0	5.25	V
Supply Voltage For LCD	V_{DD}-V_0	Ta=-20?	-	-	13.9	V
		Ta=25?	-	12.5	-	V
		Ta=+70?	10.1	-	-	V
Input High Volt.	V_{IH}	-	V_{DD} -2.2	-	V_{DD}	V
Input Low Volt.	V_{IL}	-	0	-	0.8	V
Output High Volt.	V_{OH}	-	V_{DD} -0.3	-	V_{DD}	V
Output Low Volt.	V_{OL}	-	0	-	0.3	V

| Supply Current | I_{DD} | $V_{DD}=5V$ | 12 | 16 | 20 | mA |

6.Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V)?	CR？2	30	-	60	deg
	(H)f	CR？2	-45	-	45	deg
Contrast Ratio	CR	-	-	5	-	-
Response Time	T rise	-	-	200	300	ms
	T fall	-	-	200	300	ms

Definition of Operation Voltage (Vop)　　　　**Definition of Response Time (Tr , Tf)**
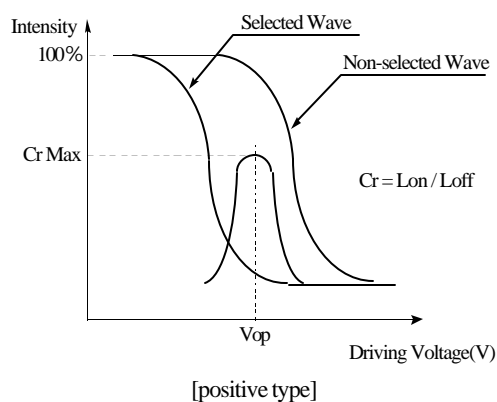
[positive type]

[positive type]
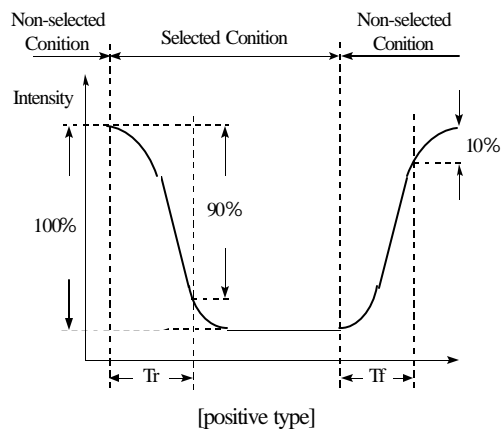
Conditions :

Operating Voltage : Vop   Viewing Angle(?，f) : 0°,   0°

Frame Frequency : 64 HZ   Driving Waveform : 1/N duty , 1/a bias

Definition of viewing angle(CR？2)
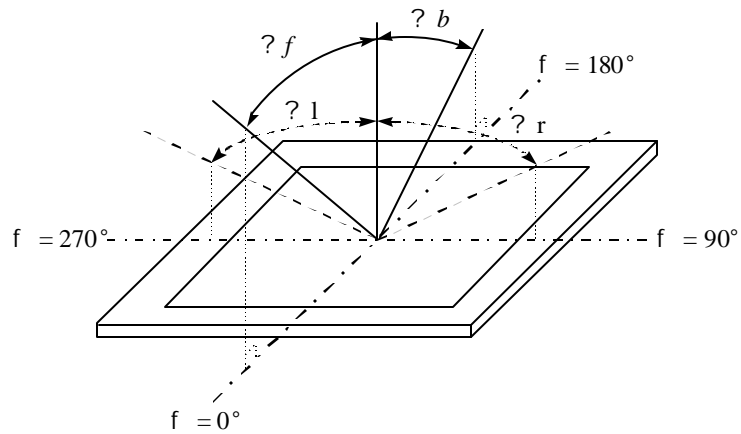
7.Interface Description

Pin No.	Symbol	Level	Description
1	FG	-	Frame ground (Connected to bezel)
2	Vss	-	GND
3	Vdd	-	Power supply (+5 V)
4	Vo	-	Power supply for LCD driver
5	WR	L	Data write. Write data into T6963C when WR = L
6	RD	L	Data read. Read data from T6963C when RD = L
7	CE	L	L : Chip enable
8	C/D	H / L	WR=L , C/D=H : Command Write C/D=L: Data write RD=L , C/D=H : Status Read C/D=L: Data read
9	Vee	-	Negative voltage
10	RESET	H / L	H : Normal ; L : Initialize T6963C
11	DB0	H / L	Data bus line
12	DB1	H / L	Data bus line
13	DB2	H / L	Data bus line
14	DB3	H / L	Data bus line
15	DB4	H / L	Data bus line
16	DB5	H / L	Data bus line
17	DB6	H / L	Data bus line
18	DB7	H / L	Data bus line
19	FS	H / L	Pins for selection of font; H : 6 * 8 , L : 8 * 8
20	N.C	-	No connection

8.Contour Drawing &Block Diagram

PIN NO.	SYMBOL
1	FGND
2	Vss
3	Vdd
4	Vo
5	WR
6	RD
7	CE
8	C/D
9	Vee
10	RESET
11	DB0
12	DB1
13	DB2
14	DB3
15	DB4
16	DB5
17	DB6
18	DB7
19	FS
20	NC

SH-2530

LED B/L

PIN DETAIL

20-⌀1.0 PTH
20-⌀1.8 PAD

DOT SIZE

The non-specified tolerance of dimension is ±0.3mm.

LED B/L drive directly from A,K .

Recommanded Value
(1) V_{LED}= 4.5V, I_{LED}= 450mA
    R= 1.8O (1/2 Watt)

(2) V_{LED}= 4.2V, I_{LED}= 660mA
    R= 1.2O (1/2 Watt)

FS	H	L
Font	6X8	8X8

Font select

MPU

80 series or 68 series

T6963C Controller

240X64 DOT

Com Driver (T6A40)

Seg1~80 Seg Driver (T6A39)
Seg81~160 Seg Driver (T6A39)
Seg160~240 Seg Driver (T6A39)

8K SRAM
32K optional

Bias and Power Circuit

N.V. Generator

Frame (Bezel)

VR 10K~20K

External contrast adjustment.

9.Display control instruction

The LCD Module has built in a T6963C LSI controller, It has an 8-bit parallel data bus and control lines for writing or reading through an MPU interface, it has a 128-word character generator ROM (refer to Table 1.), which can control an external display RAM of up to 8K bytes. Allocation of text, graphics and external character generator RAM can be made easily and the display window can be moved freely within the allocated memory range.

•**RAM Interface**

The external RAM is used to store display data(text, graphic and external CG data). It can be freely allocated to the memory area(8 K byte max).

Recommend

0000H	TEXT AREA
0C00H	GRAPHIC AREA
1800H	CG RAM AREA
2000H	
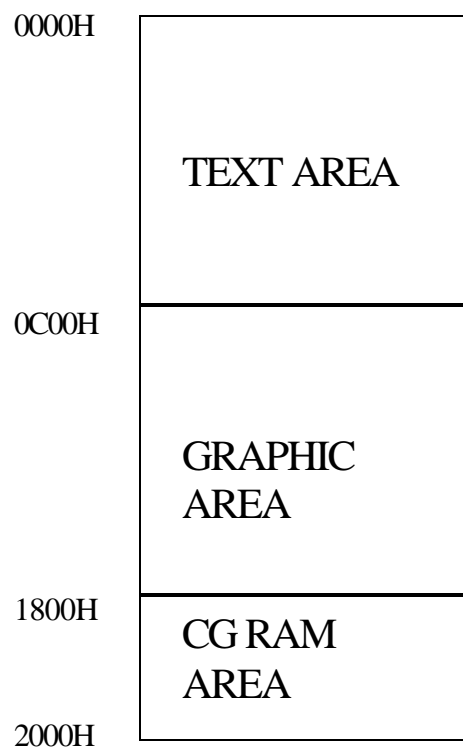
? Flowchart of communications with MPU

(1) Status Read

A status check must be performed before data is read or written.

Status check

The Status of T6963C can be read from the data lines.

$\overline{RD}$	L
$\overline{WR}$	H
$\overline{CE}$	L
C/D	H
Do to D7	H

The T6963C status word format is as follows:

MSB   LSB

STA7	STA6	STA5	STA4	STA3	STA2	STA1	STA0
D7	D6	D5	D4	D3	D2	D1	D0

STA0	Check command execution capability	0:Disable 1:Enable
STA1	Check data read/write Capability	0:Disable 1:Enable
STA2	Check Auto mode data read capability	0:Disable 1:Enable
STA3	Check Auto mode data write capability	0:Disable 1:Enable
STA4	Not used	-
STA5	Check controller operation capability	0:Disable 1:Enable
STA6	Error flag. Used for Screen Peek and Screen copy commands.	0:No error 1:Error
STA7	Check the blink condition	0:Disable off 1:Normal display

(Note 1) It is necessary to check STA0 and STA1 at the same time.

There is a possibility of erroneous operation due to a hardware interrupt.
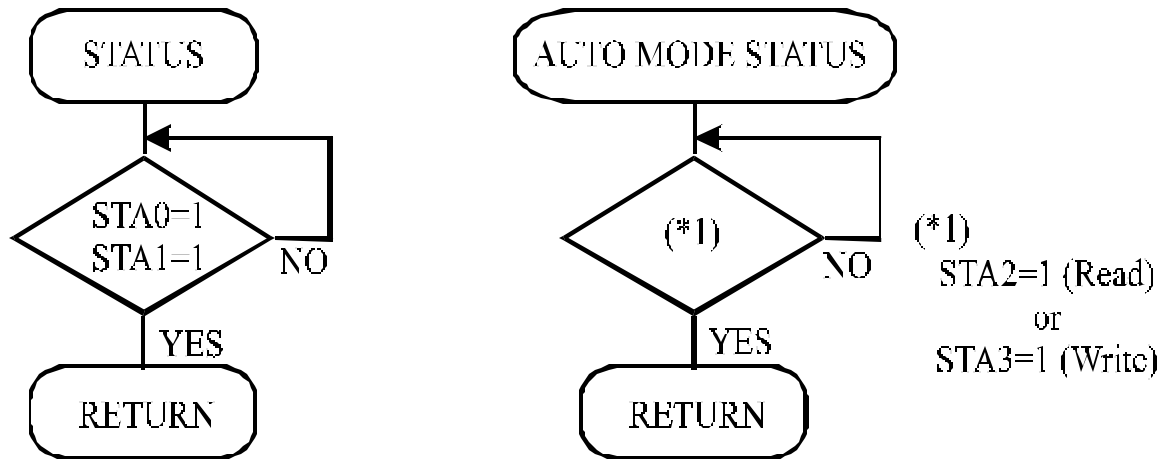
(Note 2) For most modes STA0/STA1 are used as a status check.

(Note 3) STA2 and STA3 are valid in Auto mode; STA0 and STA1 are invalid.

Status Checking flow

(a)   (b)

STATUS → STA0=1 STA1=1 — NO → (loops back) YES → RETURN

AUTO MODE STATUS → (*1) — NO → (loops back) YES → RETURN

(*1) STA2=1 (Read) or STA3=1 (Write)

(Note 4) When using the MSB=0 command, a Status Read must be performed.

If a status check is not carried out, the T6963C cannot operate normally, even after a delay time.

The hardware interrupt occurs during the address calculation period (at the end of each line).

If a MSB=0 command is sent to the T6963C during this period, the T6963C enters Wait status.

If a status check is not carried out in this state before the next command is sent, there is the possibility that the command or data date will not be received.

(2) Setting date

When using the T6963C, first set the data, then set the command.

Procedure for sending a command

(a)The case of 1 date   (b)The case of 2 data

send command → Status check (STA0, 1) → Data write → Status check → Command write → END

send command → Status check (STA0, 1) → Data write → Status check → Date write → Status check → Command write → END
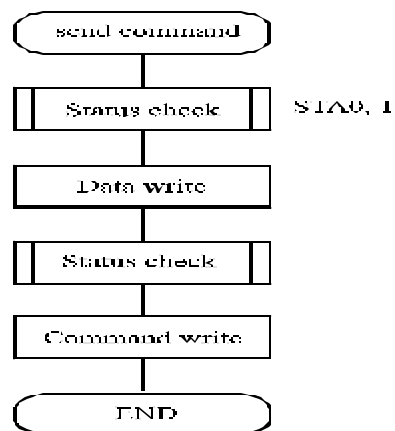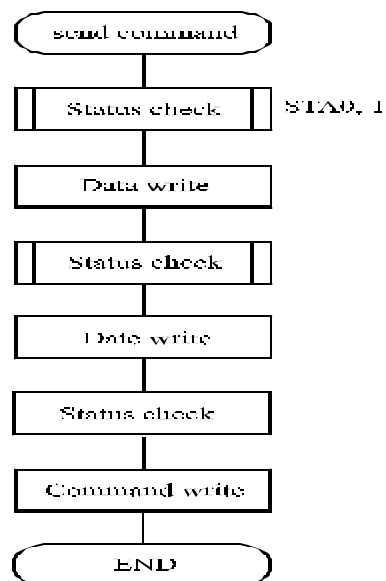
(Note)   When sending more than two data, the last datum (or last two data) is valid.

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COMMAND	CODE	D1	D2	FUNCTION
REGISTERS SETTING	00100001	X address	Y address	Set Cursor Pointer
	00100010	Date	00H	Set Offset Register
	00100100	Low address	High address	Set Address Pointer
	01000000	Low address	High address	Set Text Home Address
SET CONTROL WORD	01000001	Columns	00H	Set Text Area
	01000010	Low address	High address	Set Graphic Home Address
	01000011	Columns	00H	Set Graphic Area
MODE SET	1000×000	-	-	OR mode
	1000×001	-	-	EXOR mode
	1000×011	-	-	AND mode
	1000×100	-	-	Text Attribute mode
	10000×××	-	-	Internal CG ROM mode
	10001×××	-	-	External CG RAM mode
DISPLAY MODE	10010000	-	-	Display off
	1001××10	-	-	Cursor on, blink off
	1001××11	-	-	Cursor on, blink on
	100101××	-	-	Text on, graphic off
	100110××	-	-	Text off, graphic on
	100111××	-	-	Text on, graphic on
CURSOR PATTERN SELECT	10100000	-	-	1-line cursor
	10100001	-	-	2-line cursor
	10100010	-	-	3-line cursor
	10100011	-	-	4-line cursor
	10100100	-	-	5-line cursor
	10100101	-	-	6-line cursor
	10100110	-	-	7-line cursor
	10100111	-	-	8-line cursor
DATA AUTO READ/WRITE	10110000	-	-	Set Data Auto Write
	10110001	-	-	Set Data Auto Read
	10110010	-	-	Auto Reset
DATA READ/WRITE	11000000	Data	-	Data Write and Increment ADP
	11000001	-	-	Data Read and Increment ADP
	11000010	Data	-	Data Write and Decrement ADP
	11000011	-	-	Data Read and Decrement ADP Data
	11000100	Data	-	Write and Nonvariable ADP
	11000101	-	-	Data Read and Nonvariable ADP
SCREEN PEEK	11100000	-	-	Screen Peek

X : invalid

COMMAND	CODE	D1	D2	FUNCTION
SCREEN COPY	11101000	-	-	Screen Copy

BIT SET/RESET		-	-	
	11110×××	-	-	Bit Reset
	11111×××	-	-	Bit Set
	1111× 001	-	-	Bit 0 (LSB)
	1111× 001	-	-	Bit 1
	1111× 010	-	-	Bit 2
	1111× 011	-	-	Bit 3
	1111× 100	-	-	Bit 4
	1111× 101	-	-	Bit 5
	1111× 110	-	-	Bit 6
	1111× 110	-	-	Bit 7 (MSB)
		-	-	

X: invalid

．Setting registers

CODE	HEX.	FUNCTION	D1	D2
00100001	21H	SET CURSOR POINTER	X ADRS	Y ADRS
00100010	23H	SET OFFSET REGISTER	DATA	00H
00100100	24H	SET ADDRESS POINTER	LOW ADRS	HIGH ADRS

(1) Set Cursor Pointer

The position of the cursor is specified by X ADRS and   Y ADRS. The cursor position can only be moved by this command. Data read/write from the MPU never changes the cursor pointer. X ADRS and Y ADRS are specified as follows.

    X ADRS   00H to 4FH (lower 7 bits are valid)

    Y ADRS   00H to 1FH (lower 5 bits are valid)

Single-Scan

X ADRS 00 to 4FH

    Y ADRS 00H to 0FH

(2) Set Offset Register

The offset register is used to determine the external character generator RAM area.

The T6963C has a 16-bit address bus as follows.

MSB   LSB

| ad15 | ad14 | ad13 | ad12 | ad11 | ad10 | ad9 | ad8 | ad7 | ad6 | ad5 | ad4 | ad3 | ad2 | ad1 | ad0 |

Offset Register Data   Character Code   Line Scan
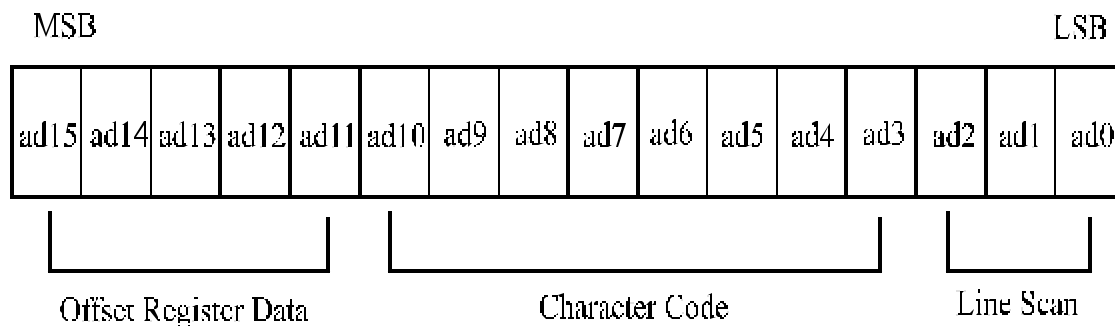
T6963C assign External character generator, when character code set 80H TO FFH in using

internal character generator. Character code 00H to 80H assign External character generator, when External generator mode.

The senior five bits define the start address in external memory of the CG RAM area. The next eight bits represent the character code of the character. In internal CG ROM, character codes 00H to 7FH represent the predefined "internal" CG ROM characters, and codes 80H to FFH represent the user's own "external" characters. In external CG ROM mode, all 256 codes from 00H to FFH can be used to represent the user's own characters. The three least significant bits indicate one of the eight rows of eight dots that define the character's shape.

The relationship between display RAM address and offset register

Offset register data	CG RAM hex. address (start to end)
00000	0000 to 07 FFH
00001	0800 to 0FFFH
00010	1000 to 17FFH
11100	E000 to E7FFH
11101	E800 to EFFFH
11110	F000 to F7FFH
11111	F800 to FFFFH

(Example 1)

Offset register	02H
Character code	80H
Character generator RAM start address	0001 0100 0000 0000
	1 4 0 0 H

(address)	(data)
1400H	00H
1401H	1FH
1402H	04H
1403H	04H
1404H	04H
1405H	04H
1406H	04H
1407H	00H

(Example 2) The relationship between display RAM data and display characters

	(RAM DATA)	(Character)
AB γ DE ζ GHIJKLM	21H	A
.	22H	B
.	83H	γ
.	24H	D
.	25H	E
.	86H	ζ
Display character		

？ and ？ are displayed by character generator RAM.

(3) Set Address Pointer

The Set Address Pointer command is used to indicate the start address for writing to (or reading from)external RAM.

The Flowchart for Set Address Pointer command

```
        ┌─────────────────────┐
        │ Set Address Pointer │
        └─────────────────────┘
                   │
        ┌─┬───────────────────┬─┐
        │ │   Status check    │ │   STA0, 1
        └─┴───────────────────┴─┘
                   │
        ┌─────────────────────┐
        │  Set Address data   │
        │   (lower 8 bits)    │
        └─────────────────────┘
                   │
        ┌─┬───────────────────┬─┐
        │ │   Status check    │ │
        └─┴───────────────────┴─┘
                   │
        ┌─────────────────────┐
        │  Set Address data   │
        │   (lower 8 bits)    │
        └─────────────────────┘
                   │
        ┌─────────────────────┐
        │    Status check     │
        └─────────────────────┘
                   │
     (upper 8 bits) ─────────
        ┌─────────────────────┐
        │ Send command 24H    │   Send Set Address Pointer command
        └─────────────────────┘
                   │
        ┌─────────────────────┐
        │        END          │
        └─────────────────────┘
```
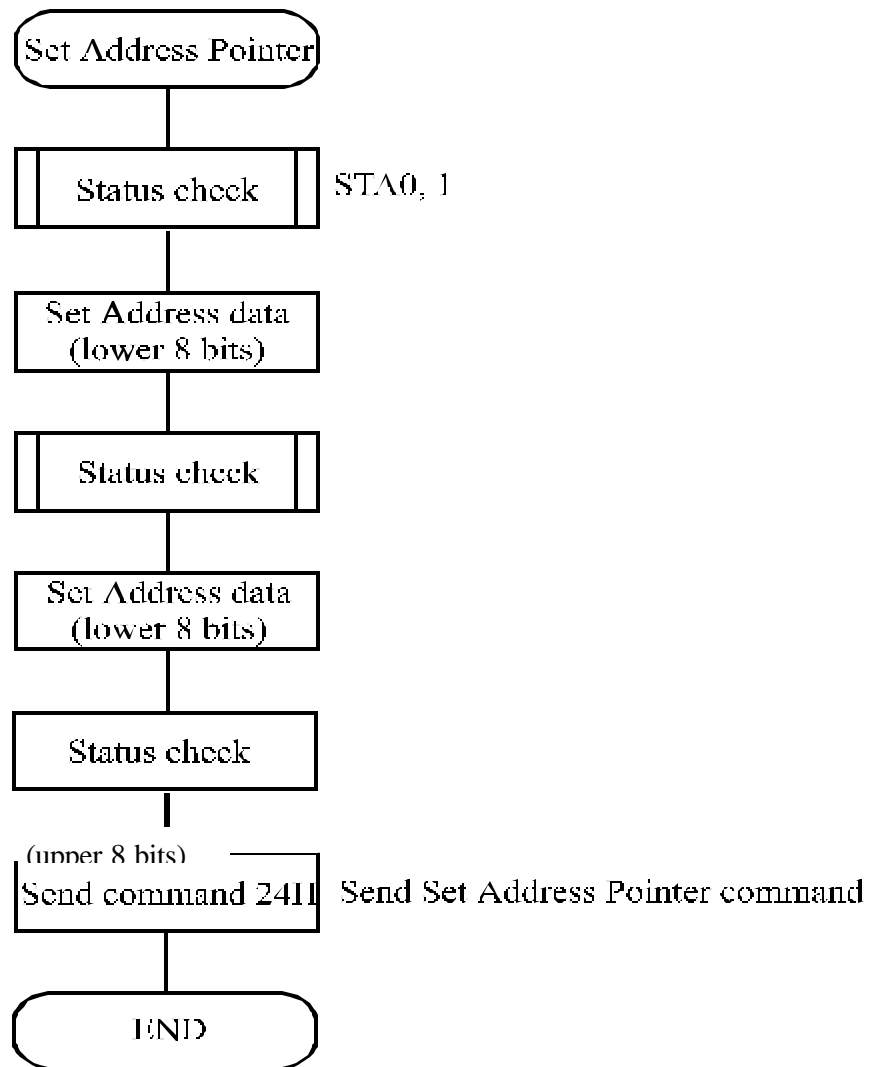
. Set Control Word

CODE	HEX.	FUNCTION	D1	D2
01000000	40H	Set Text Home Address	Low address	High address

01000001	41H	Set Text Area	Columns	00H
01000010	42H	Set Graphic Home Address	Low address	High address
01000011	43H	Set Graphic Area	Columns	00H

The home address and column size are defined by this command.

(1) Set Text Home Address

The starting address in the external display RAM for text display is defined by this command.

The text home address indicates the leftmost and uppermost position.

The relationship between external display RAM address and display position

TH	-	TH+CL
TH+TA	-	TH+TA+CL
(TH+TA)+TA	-	TH+2TA+CL
(TH+2TA)+TA	-	TH+3TA+CL
-	-	-
TH+(n-1) TA	-	TH+(n-1) TA+CL

TH: Text home address

TA: Text area number (columns)

CL: Columns are fixed by hardware (pin-programmable).

(Example)

Text home address : 0000H

Text area : 0020H

: 32 Columns

: 4 Lines

0000H	0001H	-	001EH	001FH
0020H	0021H	-	003EH	002FH
0040H	0041H	-	005EH	005FH
0060H	0061H	-	007EH	007FH

(2) Set Graphic Home Address

The starting address of the external display RAM used for graphic display is defined by this

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command. The graphic home address indicates the leftmost and uppermost position.

The relationship between external display RAM address and display position

GH	-	GH+GL
GH+GA	-	GH+GA+CL
(GH+GA)+GA	-	GH+2GA+CL
(GH+2GA)+GA	-	GH+3GA+CL
-	-	-
GH+(n-1) GA	-	GH+(n-1) GA+CL

GH: Graphic home address

GA: Graphic area number (columns)

CL: Columns are fixed by hardware (pin-programmable).

(Example)

Graphic home address : 0000H

Graphic area : 0020H

: 32 Columns

: 2 Lines

0000H	0001H	-	001EH	001FH
0020H	0021H	-	003EH	003FH
0040H	0041H	-	005EH	005FH
0060H	0061H	-	007EH	007FH
0080H	0081H	-	009EH	009FH
00A0H	00A1H	-	00BEH	00BFH
00C0H	00C1H	-	00DEH	00DFH
00E0H	00E1H	-	00FEH	00FFH
0100H	0101H	-	011EH	011FH

0120H	0121H	-	013EH	013FH
0140H	0141H	-	015EH	014FH
0160H	0161H	-	017EH	017FH
0180H	0181H	-	109EH	019FH
01A0H	01A1H	-	01BEH	01BFH
01C0H	01C 1H	-	01DEH	01DFH
01E0H	01E1H	-	01FEH	01FFH

(3) Set Text Area

The display columns are defined by the hardware Setting. This command can be used to adjust the columns of the display.

(Example)

LCD size	20 columns, 4lines
Text home address	0000H
Text area	0014H

Set 32 columns, 4 Lines

0000	0001	....	0013	0014	....	001F
0014	0015	....	0027	0028	....	0033
0028	0029	....	003B	003C	....	0047
003C	003D	....	004F	0050	....	005B

LCD

(4) Set Graphic Area

The display columns are defined by the hardware setting. This command can be used to adjust the columns of the graphic display.

(Example)

LCD size	20 columns, 2lines
Graphic home address	: 0000H
Graphic are	: 0014H

Set 32 columns, 2 Lines

0000	0001	………	0013	0014	………	001F
0014	0015	………	0027	0028	………	0033
0028	0029	………	003B	003C	………	0047
003C	003D	………	004F	0050	………	005B
0050	0051	………	0063	0064	………	006F
0064	0065	………	0077	0078	………	0083
0078	0079	………	008B	008C	………	0097
008C	008D	………	009F	00A0	………	00AB
00A0	00A1	………	00B3	00B4	………	00BF
00B4	00B5	………	00C7	00C8	………	00D3
00C8	00C9	………	00DB	00DC	………	00E7
00DC	00DD	………	00EF	00F0	………	00FD
00F0	00F1	………	0103	0104	………	011F
0104	0105	………	0127	0128	………	0123
0128	0129	………	013B	0013C	………	00147
013C	013D	………	014F	0150	………	015B

———————— LCD ————————

If the graphic area setting is set to match the desired number of columns on the LCD, the addressing scheme will be automatically modified so that the start address of each line equals the end address of the previous line +1.

. Mode set

| CODE	FUNCTION	OPERAND
1000x000	OR Mode	-
1000x001	EXOR Mode	-
1000x011	AND Mode	-
1000x100	TEXT ATTRIBUTE Mode	-
10000xxx	Internal Character Generator Mode	-
10001xxx	External Character Generator Mode	-

X: invalid

The display mode is defined by this command. The display mode does not change until the next command is sent. The logical OR, EXOR, AND of text or graphic display can be displayed. In Internal Character Generator mode, character codes 00H to 7FH are assigned to the built-in character generator ROM. The character codes 80H to FFH are automatically assigned to the external character generator RAM.
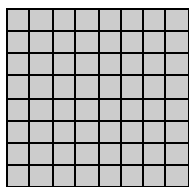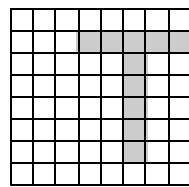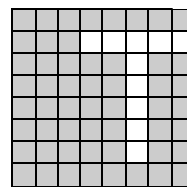
(Example)
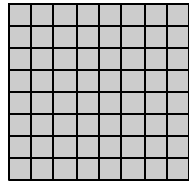
GRAPHIC
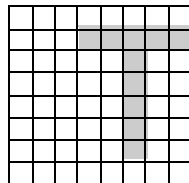
TEXT

"OR"

"AND"

"EXOR"

(Note) Attribute functions can only be applied to text display, since the attribute data is placed in the graphic RAM area.

Attribute function

The attribute operations are Reverse display, Character blink and Inhibit. The attribute data is written into the graphic area which was defined by the Set Control Word command. Only text display is possible in Attribute Function mode; graphic display is automatically disabled. However, the Display Mode command must be used to turn both Text and Graphic on in order for the Attribute function to be available.

The attribute data for each character in the text area is written to the same address in the graphic area. The Attribute function is defined as follows.

Attribute RAM 1byte

×	×	×	×	d3	d2	d1	d0

d3	d2	d1	d0	FUNCTION
0	0	0	0	Normal display
0	1	0	1	Reverse display
0	0	1	1	Inhibit display
1	0	0	0	Blink of normal display
1	1	0	1	Blink of reverse display
1	0	1	1	Blink of inhibit display

X: invalid

? Display mode

CODE	FUNCTION	OPERAND	
10010000	Display off	-	
1001xx10	Cursor on, blink off	-	
1001xx11	Cursor on, blink on	-	
100101xx	Text on, graphic off	-	
100110xx	Text off, graphic on	-	X:invalid
100111xx	Text on, graphic on	-	

1	0	0	1	D3	D2	D1	D0

- Cursor blink   on:1, off:0
- Cursor display   on:1, off:0
- Text display   on:1, off:0
- Graphic display   on:1, off:0
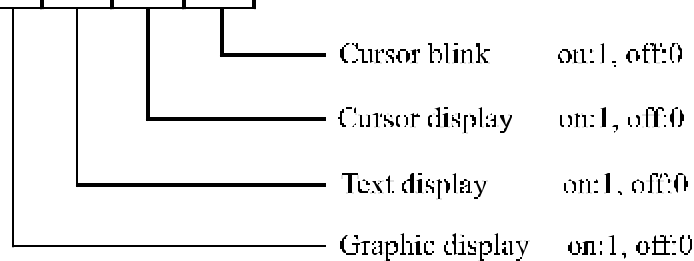
(Note) It is necessary to turn on "Text display" and "Graphic display" in the following cases.

      a) Combination of text/graphic display

      b) Attribute function

? Cursor pattern select

CODE	FUNCTION	OPERAND
10100000	1-line cursor	-
10100001	2-line cursor	-
10100010	3-line cursor	-
10100011	4-line cursor	-

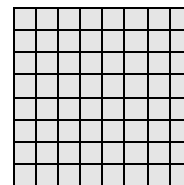| 10100100	5-line cursor	-
10100101	6-line cursor	-
10100110	7-line cursor	-
10100111	8-line cursor	-

When cursor display is ON, this command selects the cursor pattern in the range 1 line to 8 lines.
The cursor address is defined by the Cursor Pointer Set command.
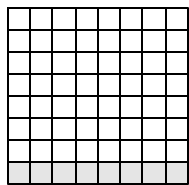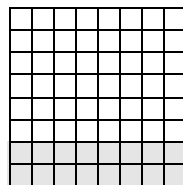
1-line cursor   2-line cursor   8-line cursor

? Data Auto Read/Write

CODE	HEX.	FUNCTION	OPERAND
10110000	B0H	Set Data Auto Write	-
10110001	B1H	Set Data Auto Read	-
10110010	B2H	Auto Reset	-

The command is convenient for sending a full screen of data from the external display RAM. After setting Auto mode, a Data Write (or Read) command is need not be sent between each datum. A Data Auto Write (or Read) command must be sent after a Set Address Pointer command. After this command, the address pointer is automatically incremented by 1 after each datum. In Auto mode, the T6963C cannot accept any other commands.
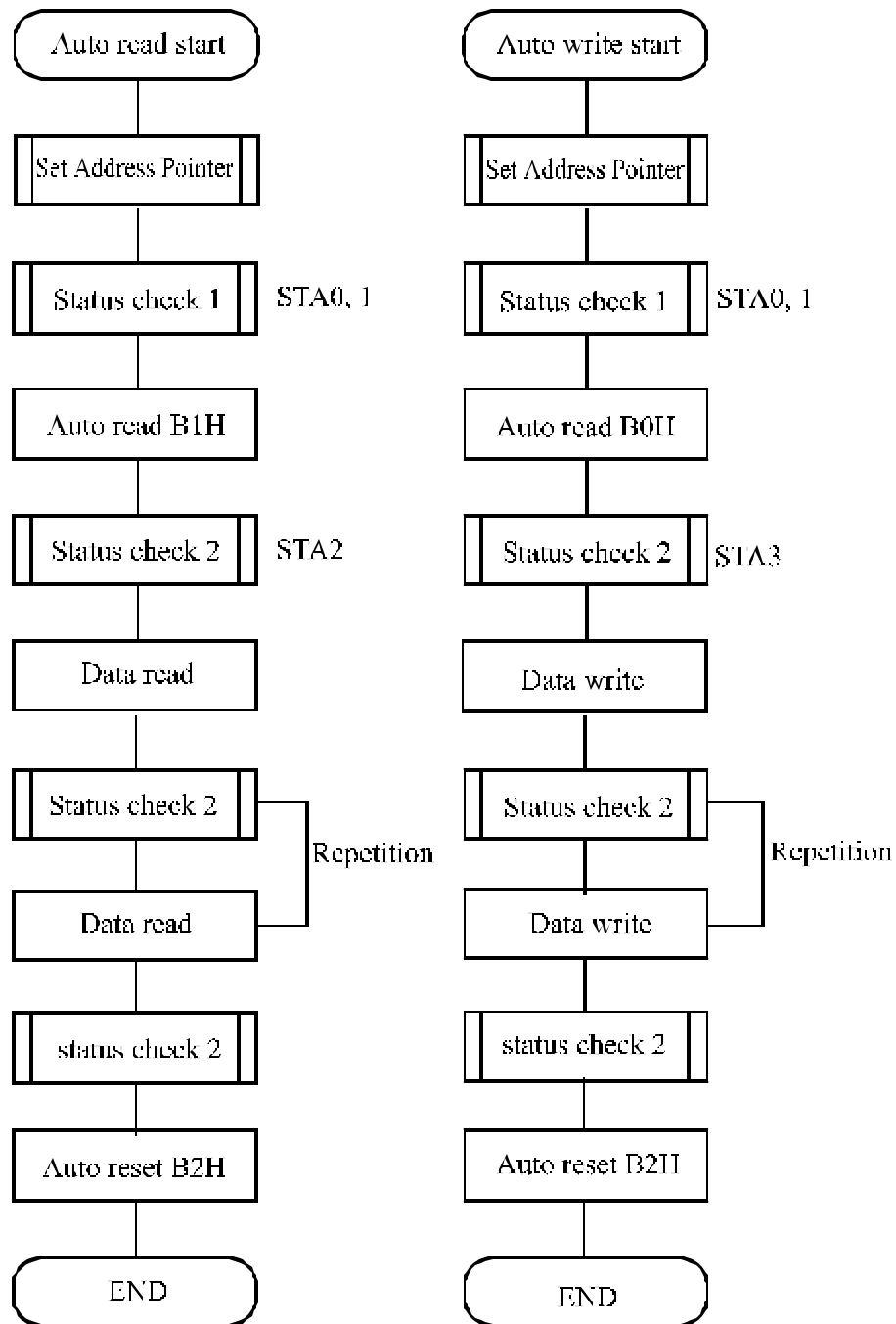
The Auto Reset command must be sent to the T69963C after all data has been sent, to clear Auto mode.
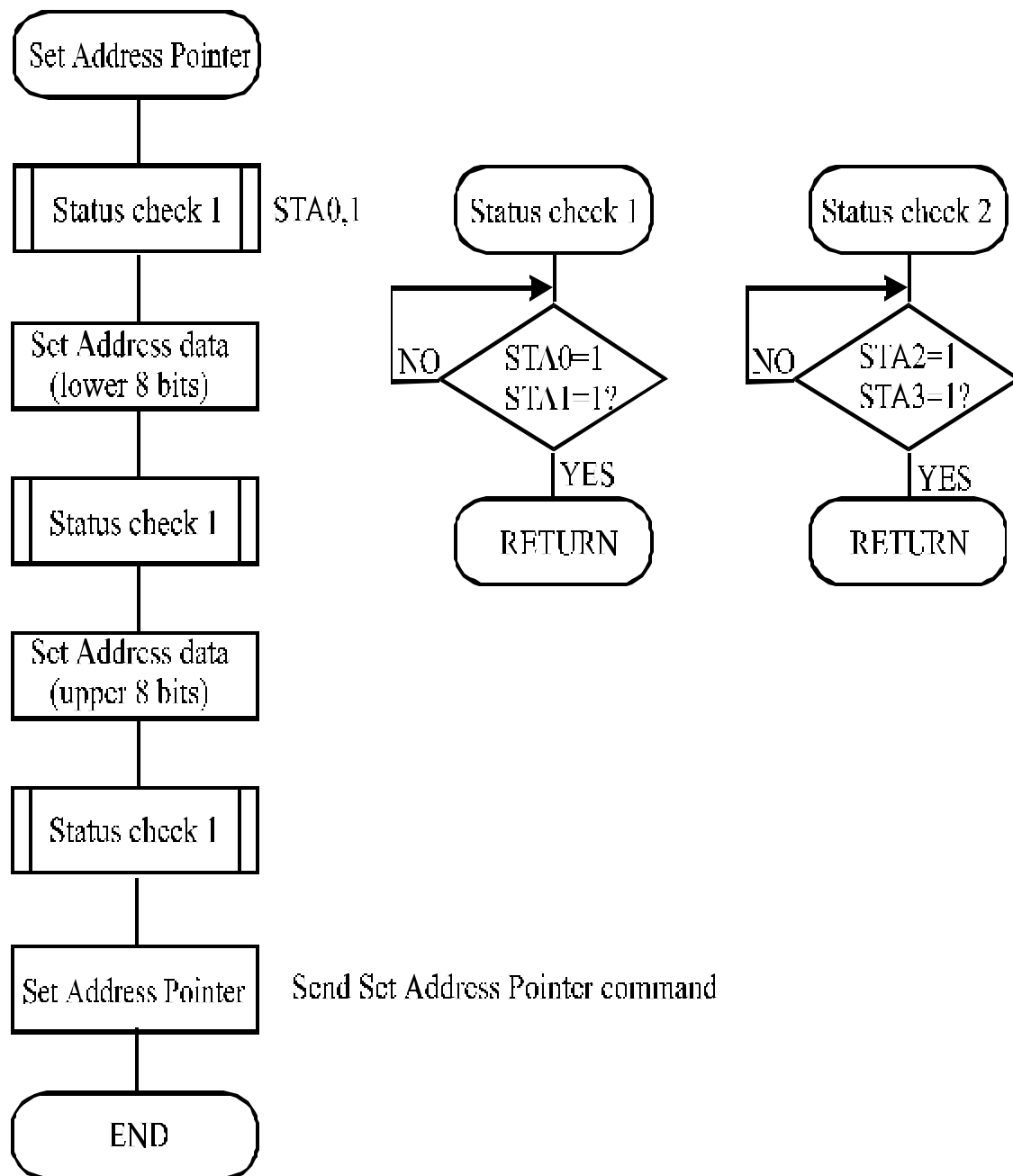
(Note) A Status check for Auto mode
      (STA2, STA3 should be checked between sending of each datum. Auto Reset should be
      performed after checking STA3=1 (STA2=1.) Refer to the following flowchart.

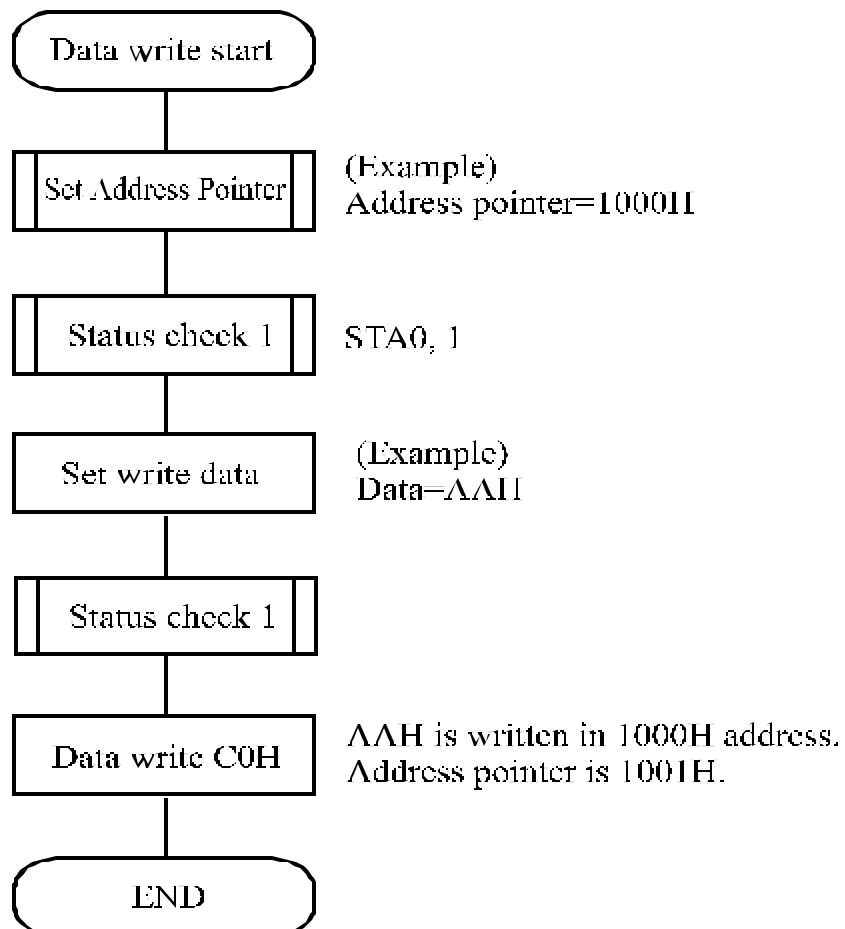 a)Auto Read mode   b)Auto Write mode

```
    ┌─────────────────┐              ┌─────────────────┐
    │ Auto read start │              │ Auto write start│
    └─────────────────┘              └─────────────────┘
            │                                │
    ┌─────────────────┐              ┌─────────────────┐
    │Set Address Pointer│            │Set Address Pointer│
    └─────────────────┘              └─────────────────┘
            │                                │
    ┌─────────────────┐  STA0, 1     ┌─────────────────┐  STA0, 1
    │ Status check 1  │              │ Status check 1  │
    └─────────────────┘              └─────────────────┘
            │                                │
    ┌─────────────────┐              ┌─────────────────┐
    │ Auto read B1H   │              │ Auto read B0H   │
    └─────────────────┘              └─────────────────┘
            │                                │
    ┌─────────────────┐  STA2        ┌─────────────────┐  STA3
    │ Status check 2  │              │ Status check 2  │
    └─────────────────┘              └─────────────────┘
            │                                │
    ┌─────────────────┐              ┌─────────────────┐
    │   Data read     │              │   Data write    │
    └─────────────────┘              └─────────────────┘
            │                                │
    ┌─────────────────┐              ┌─────────────────┐
    │ Status check 2  │─┐            │ Status check 2  │─┐
    └─────────────────┘ │ Repetition └─────────────────┘ │ Repetition
            │           │                    │           │
    ┌─────────────────┐ │            ┌─────────────────┐ │
    │   Data read     │─┘            │   Data write    │─┘
    └─────────────────┘              └─────────────────┘
            │                                │
    ┌─────────────────┐              ┌─────────────────┐
    │ status check 2  │              │ status check 2  │
    └─────────────────┘              └─────────────────┘
            │                                │
    ┌─────────────────┐              ┌─────────────────┐
    │ Auto reset B2H  │              │ Auto reset B2H  │
    └─────────────────┘              └─────────────────┘
            │                                │
    ┌─────────────────┐              ┌─────────────────┐
    │      END        │              │      END        │
    └─────────────────┘              └─────────────────┘
```

```
┌─────────────────────────┐
│   Set Address Pointer   │
└─────────────────────────┘
            │
┌─┃─────────────────┃─┐
│ ┃  Status check 1 ┃ │   STA0,1
└─┃─────────────────┃─┘
            │
┌─────────────────────────┐
│     Set Address data    │
│      (lower 8 bits)     │
└─────────────────────────┘
            │
┌─┃─────────────────┃─┐
│ ┃  Status check 1 ┃ │
└─┃─────────────────┃─┘
            │
┌─────────────────────────┐
│     Set Address data    │
│      (upper 8 bits)     │
└─────────────────────────┘
            │
┌─┃─────────────────┃─┐
│ ┃  Status check 1 ┃ │
└─┃─────────────────┃─┘
            │
┌─────────────────────────┐
│    Set Address Pointer  │   Send Set Address Pointer command
└─────────────────────────┘
            │
┌─────────────────────────┐
│           END           │
└─────────────────────────┘
```

Status check 1

NO ← STA0=1 STA1=1? → YES → RETURN

Status check 2

NO ← STA2=1 STA3=1? → YES → RETURN

? Date Read/Write

CODE	HEX.	FUNCTION	OPERAND
11000000	C0H	Data Write and Increment ADP	Data
11000001	C1H	Data Read and Increment ADP	-
11000010	C2H	Data Write and Decrement ADP	Data
11000011	C3H	Data Read and Decrement ADP	-
11000100	C4H	Data Write and Nonvariable ADP	Data
11000101	C5H	Data Read and Nonvariable ADP	-

This command is used for writing data from the MPU to external display RAM, and reading data from external display RAM to the MPU. Data Write/Data Read should be executed after setting address using Set Address Pointer command. The address pointer can be automatically incremented or decremented using this command.

(Note) This command is necessary for each 1-byte datum.

Refer to the following flowchart.

Data write start

Set Address Pointer — (Example) Address pointer=1000H

Status check 1 — STA0, 1

Set write data — (Example) Data=AAH

Status check 1

Data write C0H — AAH is written in 1000H address. Address pointer is 1001H.

END

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? Screen Peek

CODE	HEX.	FUNCTION	OPERAND
11100000	E0H	Screen Peek	- e

This command is used to transfer 1 byte of displayed data to the data stack; this byte can then be read from the MPU by data access. The logical combination of text and graphic display data on the LCD screen can be read by this command.

The status (STA6) should be checked just after the Screen Peek command. If the address determined by the Set Address Pointer command is not in the graphic area, this commands is ignored and a status flag (STA6) is set.

Refer to the following flowchart.

(*) Status check STA6=0?
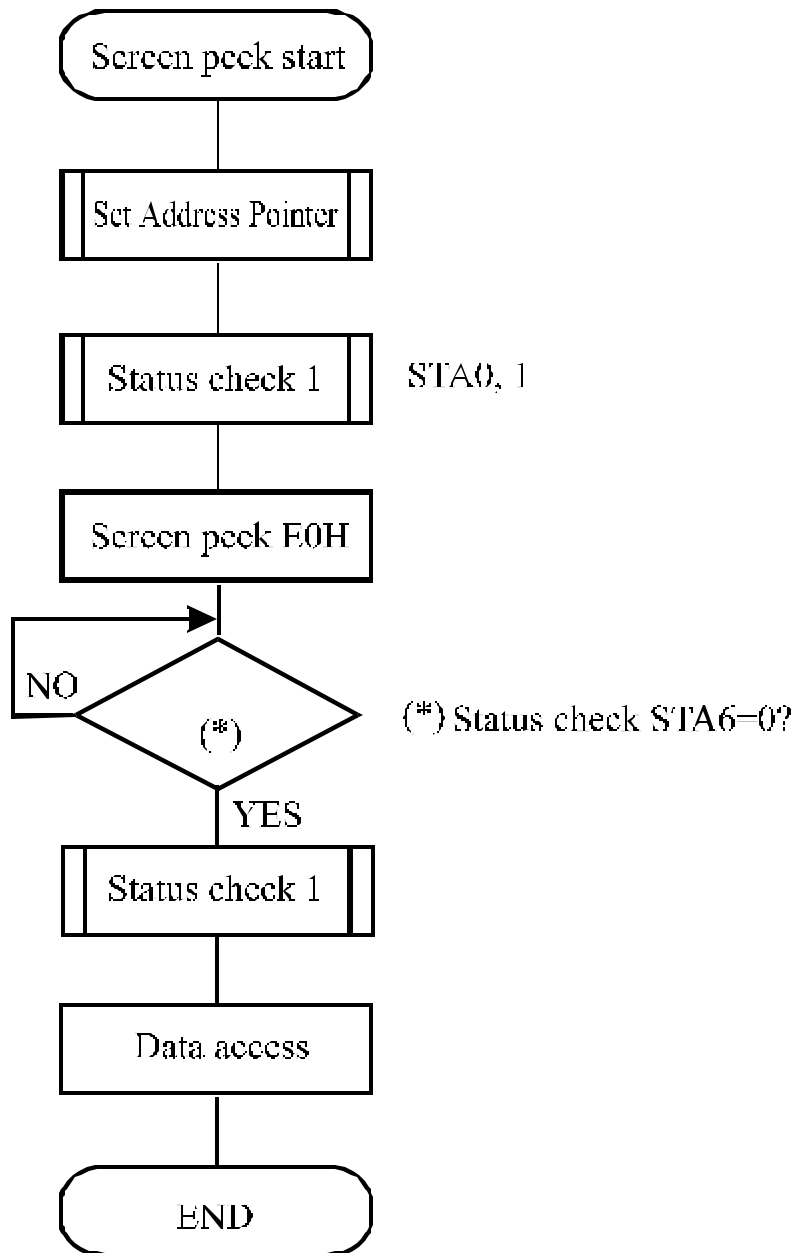
? Screen Copy

CODE	HEX.	FUNCTION	OPERAND
11101000	E8H	Screen Copy	-

This command copies a single raster line of data to the graphic area.

The start point must be set using the Set Address Pointer command.

(Note 1) If the attribute function is being used, this command is not available.

(With Attribute data is graphic area data.)

Refer to the following flowchart.

```
                    ┌─────────────────────┐
                    │  Screen copy start  │
                    └─────────────────────┘
                              │
        ┌─────────────────────┤
        │              ┌───────────────────┐
        │              │ Set Address Pointer│
        │              └───────────────────┘
        │                      │
        │              ┌───────────────────┐
        │              │  Status check 1   │   STA0,1
        │              └───────────────────┘
        │                      │
        │              ┌───────────────────┐
        │              │  Screen copy E8H  │
        │              └───────────────────┘
        │                      │
        │                      │◄──────────────┐
   YES  │                   ╱─────╲            │
        └──────────────────╱ (*1)  ╲           │
                           ╲       ╱           │
                            ╲─────╱            │
                              │ NO             │
                           ╱─────╲       NO    │
                          ╱ (*2)  ╲────────────┘
                          ╲       ╱
                           ╲─────╱
                              │ YES
                    ┌─────────────────────┐
                    │        END          │
                    └─────────────────────┘
```

(*1)Status check STA6=1
(*2)Status check STA0/1=1
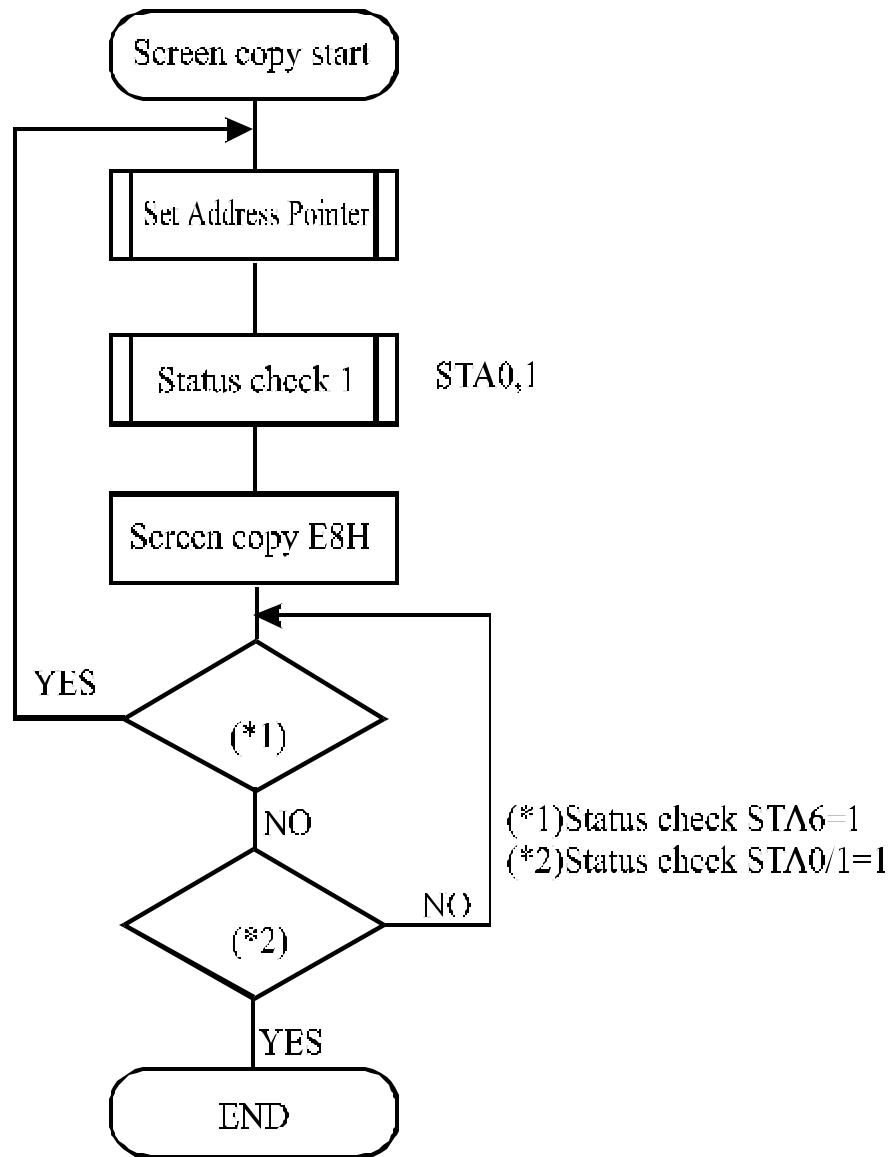
? Bit Set/Reset

CODE	FUNCTION	OPERAND
11110xxx	Bit Reset	-
11111xxx	Bit Set	-
1111x000	Bit 0 (LSB)	-
1111x001	Bit 1	-

1111x010	Bit 2	-
1111x011	Bit 3	-
1111x100	Bit 4	-
1111x101	Bit 5	-
1111x110	Bit 6	-
1111x111	Bit 7 (MSB)	-

X: invalid

This command use to set or reset a bit of the byte specified by the address pointer.

Only one bit can be set/reset at a time.

Refer to the following flowchart.

```
      ┌─────────────────────┐
      │   Bit Set/Reset     │
      └─────────────────────┘
                │
      ┌─────────────────────┐
      ║ Set Address Pointer ║
      └─────────────────────┘
                │
      ┌─────────────────────┐
      ║  Status check 1     ║      STA0,1
      └─────────────────────┘
                │
      ┌─────────────────────┐
      │   Set write data    │
      └─────────────────────┘
                │
      ┌─────────────────────┐
      ║  Status check 1     ║
      └─────────────────────┘
                │
      ┌─────────────────────┐
      │   Bit Set (reset)   │
      └─────────────────────┘
                │
      ┌─────────────────────┐
      │        END          │
      └─────────────────────┘
```
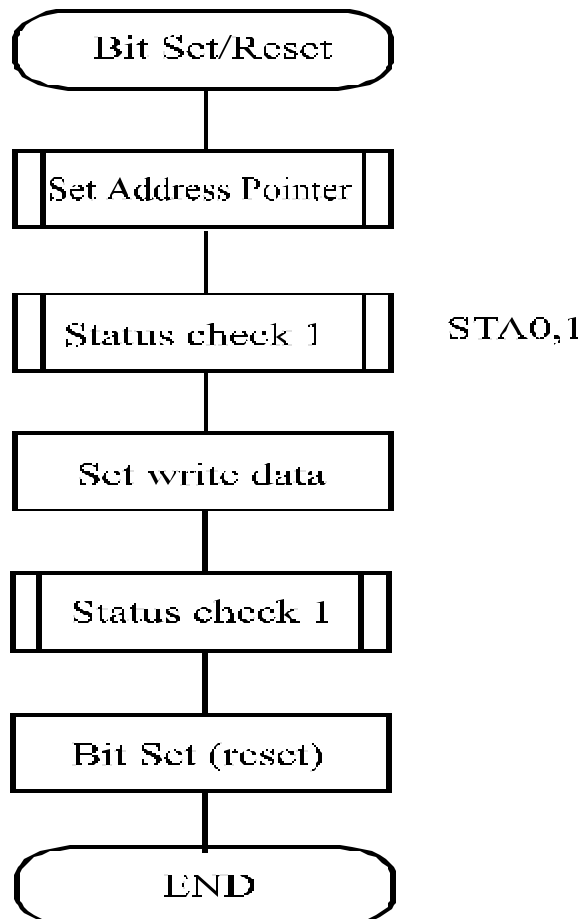
Upper 4 bit / Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH
LLLL			P	`	p			
LLLH	!	1	A	Q	a	q		
LLHL	"	2	B	R	b	r		
LLHH	#	3	C	S	c	s		
LHLL	$	4	D	T	d	t		
LHLH	%	5	E	U	e	u		
LHHL	&	6	F	V	f	v		
LHHH	'	7	G	W	g	w		
HLLL	(	8	H	X	h	x		
HLLH	)	9	I	Y	i	y		
HLHL	*	:	J	Z	j	z		
HLHH	+	;	K	[	k	{		
HHLL	,	<	L	\	l				
HHLH	-	=	M	]	m	}		
HHHL	.	>	N	^	n				
HHHH	/	?	O	_	o				

10.Timing Characteristics
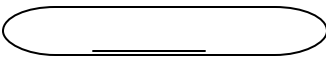
Bus Timing

($V_{SS} = 0$ V , $V_{DD} = 5$ V)

Item	Symbol	Min	Typ	Max	Unit
C/D Set-up Time	t_{CDS}	100	-	-	ns
C/D Hold Time	t_{CDH}	10	-	-	ns
CE, RD, WR Pulse Width	t_{CDS}, t_{RD}, t_{WR}	80	-	-	ns
Data Set-up Time	t_{DS}	80	-	-	ns
Data Hold Time	t_{DH}	40	-	-	ns
Access Time	t_{ACC}	-	-	150	ns
Output Hold Time	t_{OH}	10	-	50	ns
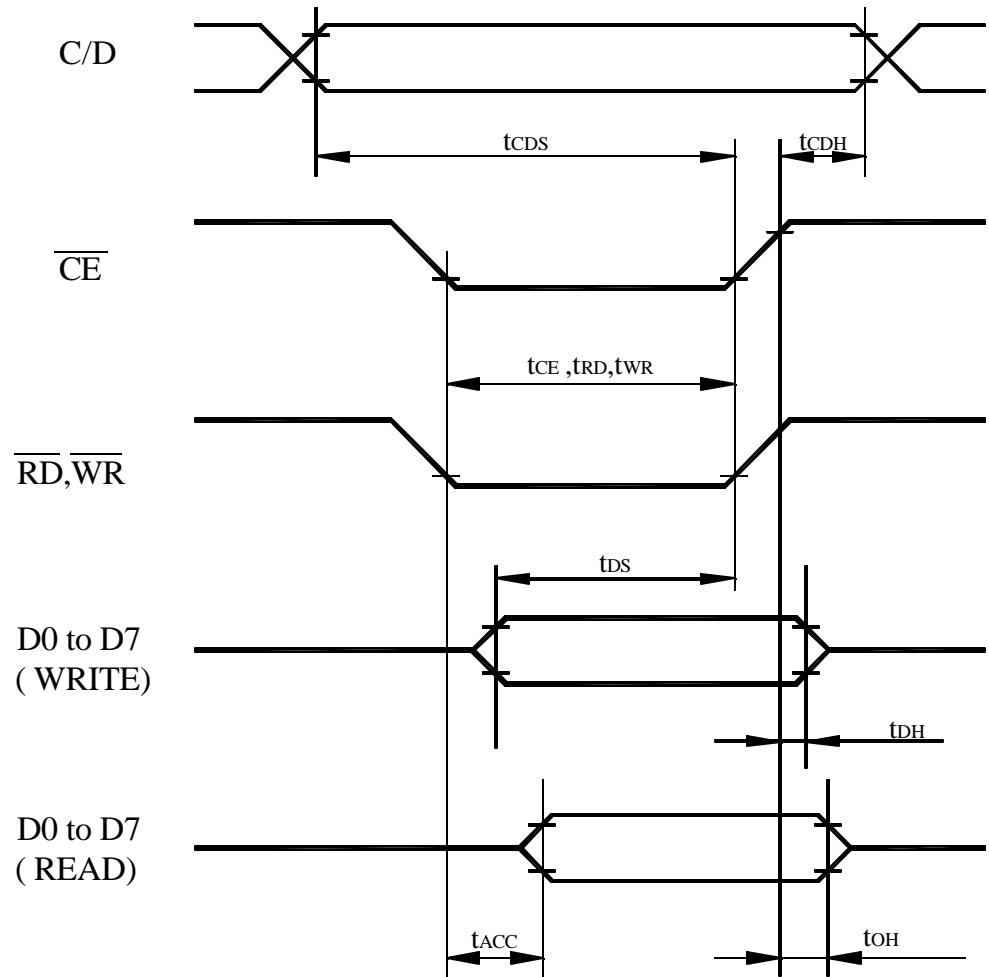
11.Reliability

Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30℃ 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	____
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 ℃ ,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60℃ ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20℃　　　25℃　　　70℃ 30min　　5min　　30min 1 cycle	-20℃ /70℃ 10 cycles	____
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 15mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΟ CS=100pF 1 time	____

Content of Reliability Test (wide temperature, -20℃ ~ 70℃)

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.
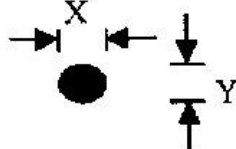
12.Backlight Information
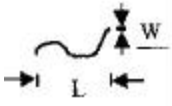
Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	**ILED**	**80**	**100**	**125**	**mA**	**V=3.5V**
Supply Voltage	**V**	**3.4**	**3.5**	**3.6**	**V**	**-**
Reverse Voltage	**VR**	**-**	**-**	**5**	**V**	**-**
Luminous Intensity	**IV**	**180**	**220**	**-**	**CD/M^2**	**ILED=100mA**
Life Time	**-**	**-**	**50K**	**-**	**Hr.**	**ILED? 100mA**
Color	**White**					

Note: The LED of B/L is drive by current only, drive voltage is for reference only.
drive voltage can make driving current under safety area (current between
minimum and maximum).

13. Inspection specification

NO	Item	Criterion		AQL
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.		0.65
02	Black or white spots on LCD (display only)	2.1 White and black spots on display ? 0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm		2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing $F = (x + y) / 2$	SIZE / Acceptable Q TY F ? 0.10 → Accept no dense 0.10< F ? 0.20 → 2 0.20< F ? 0.25 → 1 0.25< F → 0	2.5

		3.2 Line type : (As following drawing)				2.5
			Length	Width	Acceptable Q TY	
			---	W? 0.02	Accept no dense	
			L? 3.0	0.02< W? 0.03	2	
			L? 2.5	0.03< W? 0.05		
			---	0.05< W	As round type	
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size F		Acceptable Q TY	2.5
			F ? 0.20		Accept no dense	
			0.20< F ? 0.50		3	
			0.50< F ? 1.00		2	
			1.00< F		0	
			Total Q TY		3	

NO	Item	Criterion	AQL
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination	

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Symbols Define:
x: Chip length   y: Chip width   z: Chip thickness
k: Seal width   t: Glass thickness a: LCD side length
L: Electrode pad length:

6.1 General glass chip :
6.1.1 Chip on panel surface and crack between panels:

z: Chip thickness	y: Chip width	x: Chip length
Z? 1/2t	Not over viewing area	x? 1/8a
1/2t< z? 2t	Not exceed 1/3k	x? 1/8a

? If there are 2 or more chips, x is total length of each chip.

6.1.2 Corner crack:

z: Chip thickness	y: Chip width	x: Chip length
Z? 1/2t	Not over viewing area	x? 1/8a
1/2t< z? 2t	Not exceed 1/3k	x? 1/8a

? If there are 2 or more chips, x is the total length of each chip.

NO	Item	Criterion	AQL
06	Chipped glass		2.5

		Symbols :	

x: Chip length   y: Chip width   z: Chip thickness
k: Seal width   t: Glass thickness   a: LCD side length
L: Electrode pad length

6.2 Protrusion over terminal :

6.2.1 Chip on electrode pad :
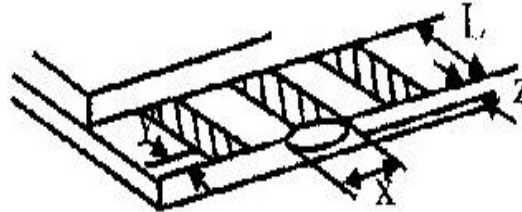
y: Chip width	x: Chip length	z: Chip thickness
y? 0.5mm	x? 1/8a	0 < z ? t

6.2.2 Non-conductive portion:
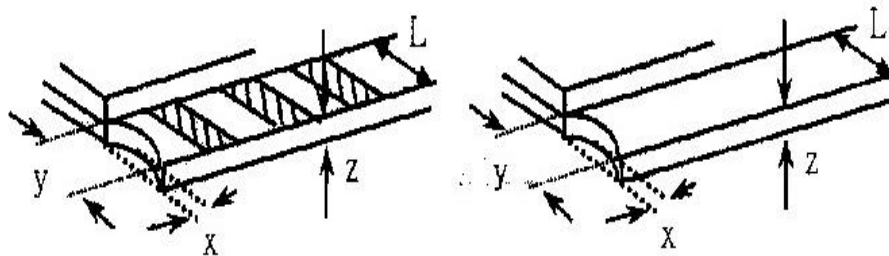
y: Chip width	x: Chip length	z: Chip thickness
y? L	x? 1/8a	0 < z ? t

  ? If the chipped area touches the ITO terminal, over 2/3 of the
    ITO must remain and be inspected according to electrode
    terminal specifications.

  ? If the product will be heat sealed by the customer, the
    alignment mark not be damaged.

6.2.3 Substrate protuberance and internal crack.
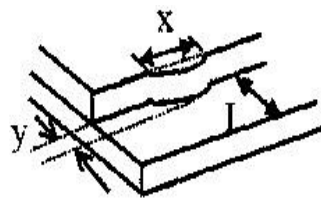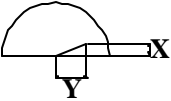
y: width	x: length
y? 1/3L	x ? a

Item 06 — Glass crack — 2.5

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong.	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB？COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB X Y $X * Y <= 2mm^2$	2.5 2.5 0.65 2.5 2.5 0.65 0.65 2.5 2.5

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NO	Item	Criterion	AQL
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet.	2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65

14. Material List of Components for RoHs

14.1 Process for WEEE and Rohs requirement

(1) We are now in the process of evaluating/converting to lead-free components/products.

(2) We use **Sn/Ag/Cu** soldering surface. The surface of pb-free solder is more **rough** than we used before.

(3) Heat-resistance temp.:

Reflow : 250? ,30 seconds Max.;

Connector soldering wave or hand soldering: 320? , 10 seconds max.

(4) Temp. curve of reflow, max. Temp.: 235± 5? ;

Recommended customer's soldering temp. of connector: 280? , 3 seconds.

(5) The LCD controller T6963c is not available now, Toshiba lead –free version will be in mass production in August.

(6) How to differentiate pb-free LCM from 2005/Apr to 2005/June, we will add a symbol "#" at the end of module's part number. The symbol "#" will be removed from 2006/7/1.

14.2 <u>Consisting material of LCM</u>

Please refer to the summarization and supplement of test report as follows:

- PAGE 1/2: Item 1 ~ 12 are Common parts list of current LCM, basically used in standard reflective LCM products.

- PAGE 2/2: Item 13 ~ 23 are optional parts list according to customer's requirement, ex.: backlight components such as CCFL B\L , LED B\L, EL .., ect., or cable connector. Please present this list to customer if these materials are used.

- Each test report is provided by notarization organization, authorized by material suppliers; the none-verified components had sent to notarization organization by Winstar. Quality and manufacturing process of all materials will be kept improving to achieve the requirement of decreasing/totally prohibiting the usage of toxic chemical substances.

LCM COMMON PARTS LIST						
NO.	Material Item	Pb	Cd	Hg	Cr(6+)	PBDEs & PBBs	Controlled Material
1	PCB-FR4	N.D.	N.D.	N.D.	N.D.	N.D.<0.0005%	F<50.0ppm CL <1386ppm Br<50.0ppm I<50.0abbr
2	PCB-GREEN Ink	N.D.	N.D.	N.D.	N.D.	-	Sb<5.0ppm As<10.0ppm Ba<10.0ppm Se<5.0ppm
3	PCB-Plate	N.D.	N.D.	N.D.	N.D.	-	As<12.9ppm Ba<14.5ppm Sb<5.0ppm Se<2.0ppm
4	Bezel Frame	77.3ppm	N.D.	N.D.	N.D.	-	
5	Plastic Frame	24.0ppm	4.8ppm	N.D.	N.D.	N.D.	
6	LCD-Glass	N.D.	N.D.	N.D.	N.D.	N.D.	
7	LCD-Polizer	N.D.	N.D.	N.D.	N.D.	N.D.	
8	Zebra Connector	N.D.	N.D.	N.D.	N.D.	N.D.	
9	Assembly Tape	N.D.	N.D.	N.D.	N.D.	N.D.	
10	Assembly Type Mylar	N.D.	N.D.	N.D.	N.D.	N.D.	
11	Solder Paste	66.7ppm	ND	N.D.	N.D.	-	
12	Packing	ND<90.0ppm	ND<75.0ppm	ND<60.0ppm	ND<60.0ppm	-	Sb<60ppm As<25ppm Ba<1000ppm Se<500ppm

Note: 1. N.D. for Pb , Cd , Hg and Cr means under 2.0ppm.

Page 1/2

2. N.D. for PBDEs and PBBs means under 0.0005%.

	LCM COMMON PARTS LIST						
NO.	Material Item	Pb	Cd	Hg	Cr(6+)	PBDEs & PBBs	Controled Material
13	CCFL-Tube (with inside material)	131ppm	N.D.	3069ppm	N.D.	ND<0.0005%	PBDE N.D. PBB N.D.
14	CCFL-Wire	256ppm	N.D.	N.D.	N.D.	N.D.	
15	CCFL B/L- Diffusion sheet	N.D.	N.D.	N.D.	N.D.	N.D.	As<0.001 Cr<0.012 Cu<0.02 Se<0.006
16	CCFL B/L-Light Guid	N.D.	N.D.	N.D.	N.D.	N.D.	
17	CCFL Tube Cover	N.D.	N.D.	N.D.	N.D.	N.D.	
18	LED B/L- Diffusion sheet	N.D.	N.D.	N.D.	N.D.	N.D.	As<2.0ppm Cr<0.007 Cu<0.31 Se<0.003
19	LED B/L-Light Guide	N.D.	N.D.	N.D.	N.D.	N.D.	
20	LED Lamp	149ppm	N.D.	N.D.	N.D.	N.D.	
21	LED B/L Reflector	N.D.	N.D.	N.D.	N.D.	N.D.	
22	EL B/L	N.D.	N.D.	N.D.	N.D.	N.D.	
23	FFC Cable Wire	N.D.	N.D.	N.D.	N.D.	-	

Note: 1. N.D. for Pb , Cd , Hg and Cr means under 2.0ppm.

2. N.D. for PBDEs and PBBs means under 0.0005%.

winstar   **LCM Sample Estimate Feedback Sheet**

Module Number: _____   **Page: 1**

1? Panel Specification:

 1.   Panel Type :   ? Pass   ? NG , _____

 2.   View Direction: ? Pass   ? NG , _____

 3.   Numbers of Dots: ? Pass   ? NG , _____

 4.   View Area: ? Pass   ? NG , _____

 5.   Active Area: ? Pass   ? NG , _____

 6.   Operating Temperature : ? Pass   ? NG , _____

 7.   Storage Temperature : ? Pass   ? NG , _____

 8.   Others: _____

2? Mechanical Specification:

 1.   PCB Size: ? Pass   ? NG ,

 2.   Frame Size :   ? Pass   ? NG , _____

 3.   Materal of Frame: ? Pass   ? NG , _____

 4.   Connector Position: ? Pass   ? NG ,

 5.   Fix Hole Position: ? Pass   ? NG , _____

 6.   Backlight Position : ? Pass   ? NG , _____

 7.   Thickness of PCB: ? Pass   ? NG , _____

 8.   Height of Frame to PCB: ? Pass   ? NG , _____

 9.   Height of Module : ? Pass   ? NG , _____

 10. Others: ? Pass   ? NG , _____

3? Relative Hole Size:

 1.   Pitch of Connector : ? Pass   ? NG , _____

 2.   Hole size of Connector : ? Pass   ? NG , _____

 3.   Mounting Hole size: ? Pass   ? NG , _____

 4.   Mounting Hole Type : ? Pass   ? NG , _____

 5.   Others: ? Pass   ? NG , _____

4? Backlight Specification:

 1. B/L Type :   ? Pass   ? NG , _____

 2. B/L Color: ? Pass   ? NG , _____

 3. B/L Driving Voltage (Reference for LED Type): ? Pass ? NG , _____

 4. B/L Driving Current: ? Pass   ? NG , _____

 5. Brightness of B/L : ? Pass   ? NG , _____

 6. B/L Solder Method: ? Pass   ? NG , _____

 7. Others: ? Pass   ? NG , _____

winstar

Module Number: _____   **Page: 2**

5? <u>Electronic Characteristics of Module</u> :

1. Input Voltage: ? Pass   ? NG , _____
2. Supply Current: ? Pass   ? NG , _____
3. Driving Voltage for LCD :   ? Pass   ? NG , _____
4. Contrast for LCD :   ? Pass   ? NG , _____
5. B/L Driving Method: ? Pass   ? NG , _____
6. Negative Voltage Output: ? Pass   ? NG , _____
7. Interface Function: ? Pass   ? NG , _____
8. LCD Uniformity :   ? Pass   ? NG , _____
9. ESD test :   ? Pass   ? NG , _____
10. Others :   ? Pass   ? NG , _____

6? <u>Summary</u> :

Sales signature : _____

Customer Signature: _____   <u>**Date**</u>:   /   /

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